SCOPE :

This specification applies to the Pb Free high current type SMD inductors for MNR-6028-SERIES

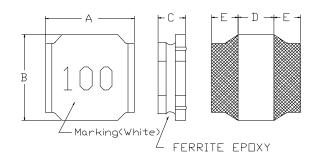
PRODUCT INDENTIFICATION

<u>MNR</u> - <u>6028</u> - <u>100</u> <u>M</u>

1	2	3	4
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- ① Product Code
- ② Dimensions Code
- ③ Inductance Code
- Tolerance Code

(1) SHAPES AND DIMENSIONS



A :	6.0±0.2	mm
B:	6.0±0.2	mm
C:	2.9±0.2	mm
D:	2.70Тур.	mm
E:	1.65Тур.	mm

(2) ELECTRICAL SPECIFICATIONS SEE TABLE 1

TEST INSTRUMENTS

- L : HP 4284A PRECISION LCR METER (or equivalent)
- SRF : HP 4291B IMPEDANCE ANALYZER (or equivalent)
- RDC : CHROMA MODEL 16502 MILLIOHMMETER (or equivalent)

(3) CHARACTERISTICS

- (3)-1 Ambient temperature +60 $^\circ\!\!\!\! C$ Max.
- (3)-2 Operate temperature range -40° C \sim $+125^{\circ}$ C
 - (Including self temp. rise)
- (3)-3 Storage temperature range $-40^\circ C \sim +125^\circ C$



TABLE 1

MAGLAYERS	Inductance	Percent	L Test	SRF(MHz)	Resistance	Rated DC Current		Marking	
PT/NO.	L(µH)	Tolerance	Frequency	Тур.	RDC(Ω)±30%	IDC1(A) IDC2(A)		Marking	
MNR-6028-R90	0.9	N	100KHz/0.25V	90	13m	6.60	4.60	R90	
MNR-6028-2R2	2.2	N	100KHz/0.25V	68	20m	4.20	3.70	2R2	
MNR-6028-4R7	4.7	M,N	100KHz/0.25V	39	31m	2.70	3.00	4R7	
MNR-6028-100	10	M,N	100KHz/0.25V	20	65m	1.90	1.90	100	
MNR-6028-220	22	M,N	100KHz/0.25V	12	0.135	1.30	1.40	220	
MNR-6028-330	33	M,N	100KHz/0.25V	10	0.22	1.10	1.10	330	
MNR-6028-470	47	M,N	100KHz/0.25V	8.0	0.30	0.95	0.92	470	
MNR-6028-680	68	M,N	100KHz/0.25V	5.0	0.42	0.76	0.77	680	
MNR-6028-101	100	M,N	100KHz/0.25V	3.0	0.60	0.62	0.66	101	
MNR-6028-221	220	M,N	100KHz/0.25V	1.0	1.30	0.45	0.50	221	

※ □ specify the inductance tolerance,M(±20%),N(±30%)

% IDC1 : Based on inductance change ($\bigtriangleup L/Lo$: drop 30% Max.) @ ambient temp. 25 $\! \ensuremath{\mathbb{C}}$

IDC2 : Based on temperature rise ($\triangle T$: 40°C Typ.)

Rated DC Current : The less value whith is IDC1 or IDC2.



(4) RELIABILITY TEST METHOD

MECHANICAL

TEST ITEM	SPECIFICATION	TEST DETAILS				
Substrate bending	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board				
		in figure 1 and a load applied unitil the figure in the arrow				
	There shall be	direction is made approximately 3mm.(keep time 30 seconds)				
	no mechanical	PCB dimension shall the page 7/9				
	damage or elec-	F(Pressurization)				
	trical damege.	Д				
		R5 45±2 45±2 1 10 20 R340				
		PRESSURE ROD figure-1				
Vibration	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board				
		and when a vibration having an amplitude of 1.52mm				
	There shall be	and a frequency of from 10 to 55Hz/1 minute repeated should				
	no mechanical	be applied to the 3 directions (X,Y,Z) for 2 hours each.				
	damage.	(A total of 6 hours)				
Solderability	New solder	Flux (rosin, isopropyl alcohol{JIS-K-1522}) shall be coated				
Solderability	More than 90%	over the whole of the sample before hard, the sample shall				
		then be preheated for about 2 minutes in a temperature of				
		130 \sim 150 $^\circ\!\mathrm{C}$ and after it has been immersed to a depth 0.5mm				
		below for 3±0.2 seconds fully in molten solder M705 with				
		a temperature of 245±5℃.				
		More than 90% of the electrode sections shall be couered				
		with new solder smoothly when the sample is taken out of				
		the solder bath.				



MECHANICAL

cor The	Temperature profile of reflow soldering $300 \xrightarrow{90}{90} \xrightarrow{90}{90} \xrightarrow{90}{90}$ (Peak temperature 2001:3° 10 sec $300 \xrightarrow{90}{90} \xrightarrow{90}{90}$
	oblems. Th col Th

ELECTRICAL

TEST ITEM	SPECIFICATION	TEST DETAILS
Insulation	There shall be	DC 100V voltage shall be applied across this sample of top
resistance	no other	surface and the terminal.
	damage or	The insulation resistance shall be more than $1 \times 10^8 \Omega$.
	problems.	
Dielectric	There shall be	AC 100V voltage shall be applied for 1 minute acrosset the top
withstand	no other	surface and the terminal of this sample
voltage	damage or	
	problems.	
Temperature	∆L/L20℃ ≦±10%	The test shall be performed after the sample has stabilized in
characteristics	0~2000 ppm/℃	an ambient temperature of -20 to +85 $^\circ\!\mathrm{C}$,and the value
		calculated based on the value applicable in a normal
		temperature and narmal humidity shall be $\triangle L/L20^{\circ}C \leq \pm 10\%$.



ENVIROMENT CHARACTERISTICS

TEST ITEM		SPECIFICATION					
High temperature	∆L/Lo≦±5%	The san	nple sl	nall be left for 96±4 hou	rs in an atmospere with	<u></u> ו	
storage		a tempe	a temperature of 85±2 $^\circ\!\!\mathbb{C}$ and a normal humidity.				
	There shall be	Upon co	Upon completion of the measurement shall be made after the				
	no mechanical	sample	has be	een left in a normal tem	perature and normal		
	damage.	humidit	y for 1	hour.			
Low temperature	∆L/Lo≦±5%	The san	nple sl	nall be left for 96±4 hou	rs in an atmosphere wi	th	
storage		a tempe	erature	of -25±3℃.			
	There shall be	Upon co	omplet	ion of the test, the mea	surement shall be made	e	
	no mechanical	after the	e sam	ole has been left in a no	rmal temperature and		
	damage.	normal	humid	ity for 1 hour.			
Change of	∆L/Lo≦±5%	The san	nple sl	nall be subject to 5 cont	inuos cycles, such as s	shown	
temperature		in the ta	able 2	pelow and then it shall I	be subjected to standar	ď	
	There shall be	atmosp	heric o	conditions for 1 hour, af	ter which measuremen	t	
	no other dama-	shall be	made				
	ge of problems						
				table 2			
				Temperature	Duration		
			1	− 25±3 ℃	30 min.		
				(Themostat No.1)			
			2	Standard	No.1→No.2		
				atmospheric			
			3	85±2℃	30 min.		
				(Themostat No.2)			
			4	Standard	No.2→No.1		
				atmospheric			
Moisture storage	∆L/Lo≦±5%	The san	The sample shall be left for 96±4 hours in a temperature of				
C C		$40\pm2^{\circ}$ and a humidity(RH) of 90~95%.					
	There shall be	Upon completion of the test, the measurement shall be made					
	no mechanical	-	after the sample has been left in a normal temperature and				
	damage.	normal	normal humidity more than 1 hour.				
Test conditions :		1					
The sample shall be reflow soldered onto the printed circuit board in every test.							

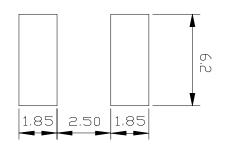


(5) LAND DIMENSION (Ref.)

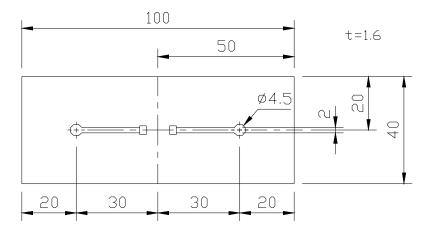
PCB: GLASS EPOXY t=1.6mm

(5)-1 LAND PATTERN DIMENSIONS

(STANDARD PATTERN) unit : mm

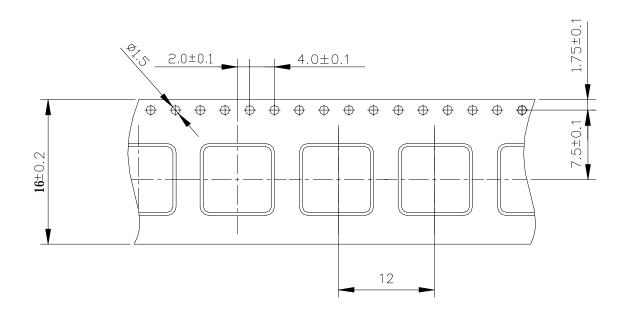


(5)-2 SUBSTRATE BENDING TEST BENDING TEST BOARD



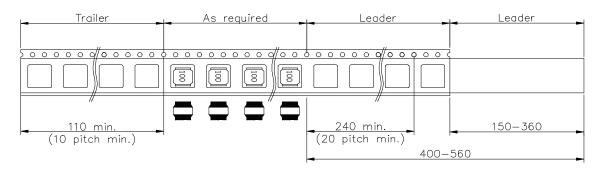


(6) PACKAGING (6)-1 CARRIER TAPE DIMENSIONS (mm)



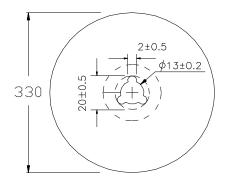
(6)-2 TAPING DIMENSIONS (mm)

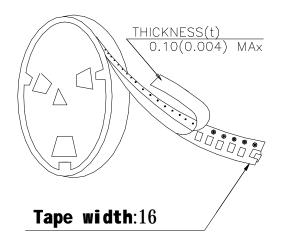






(6)-3 REEL DIMENSIONS (mm)





(6)-4 QUANTITY

1000 pcs/Reel

The products are packaged so that no damage will be sustained.

